

Global IC-Substrate Market Data Survey Report 2013-2025

https://marketpublishers.com/r/G4143B6DAF9EN.html

Date: April 2019

Pages: 84

Price: US\$ 1,500.00 (Single User License)

ID: G4143B6DAF9EN

Abstracts

SUMMARY

IC substrate is a type of carry material for integrated circuit with internal circuit to connect the chips and PCBs. Additionally, the IC substrate can protect the circuit, special line, it is designed for heat dissipation and acts standardized module of IC components. It is one of the most key materials of the IC packaging, and the share of IC substrate for IC packaging is as high as 35-55%.

The global IC-Substrate market will reach xxx Million USD in 2019 with CAGR xx% 2019-2025. The main contents of the report including:

Global market size and forecast
Regional market size, production data and export & import
Key manufacturers profile, products & services, sales data of business
Global market size by Major Application
Global market size by Major Type

Key manufacturers are included based on company profile, sales data and product specifications etc.:

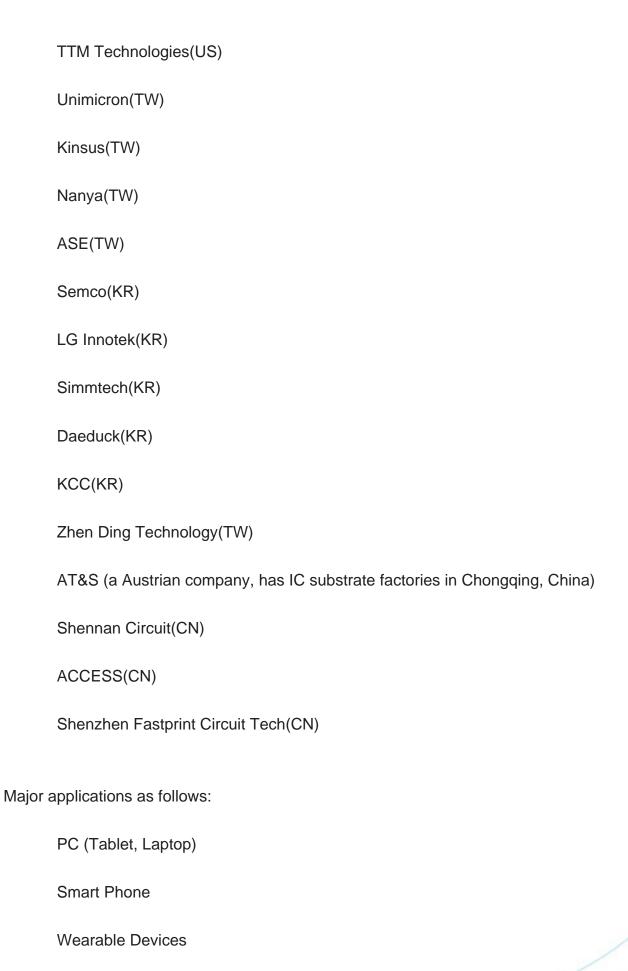
Ibiden(JP)

Shinko Electric Industries(JP)

Kyocera(JP)

Eastern(JP)







	Others	
Major Type as follows:		
	FC-CSP	
	FC-BGA	
	CSP	
	BGA	
Regior	nal market size, production data and export & import: Asia-Pacific North America Europe South America Middle East & Africa	



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